



## Introducing New Improved Dyna-Purge K for K 2010



Dyna-Purge K with improved expansion and cleaning action

***Advanced formulation provides a brighter, more powerful clean by expanding and cleaning hard to reach areas***

The **Dyna-Purge® Division of Shuman Plastics, Inc.**, USA has introduced the company's latest technology breakthrough -- New & Improved Dyna-Purge K, a low-temperature, non-abrasive, non-chemical engineered thermoplastic purging compound. The product launched in the UK by Shuman Plastics sole distributor CJP Sales Ltd K is specially formulated to flow naturally through the machine and provide for a "dual power" cleaning technology. A non-melting but softening thermoplastic scrubs while a proprietary ingredient expands, removing contamination without leaving residue.

Developed as part of the company's continuous product innovation program, Dyna-Purge K is ideal for processing temperatures ranging from 143°C to 287°C (290°F to 550°F).

Furthermore, like the company's other products, New & Improved Dyna-Purge K is easy to use, with no mixing, soaking or machine adjustments required. It is suitable for purging many types of hot runner systems, removing the build up of polymer residue. When used as an essential component of the start up and shut down procedure Dyna-Purge removes carbon eliminating black specs in production mouldings.

New Dyna-Purge K will be launched at the K 2010 show in October, where representatives from Shuman Plastics Inc and Distributors from Europe, including [CJP Sales Ltd](#) from the UK will be available to discuss purging solutions. Please visit our stand 13/B91-21 at K 2010.

*"Dyna-Purge is a registered trademark of Shuman Plastics, Inc. "*